African Centre for Advanced Studies National Advanced School of Engineering, UYI

# ELECTRIC AND ELECTRONIC CIRCUITS PHY 225

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Electric and electronic circuits - Phys 225 - National Advanced School of Engineering - UYI - 2020

D. B E

#### Overview

**Objectives:** Communicate to the student the basic concepts of design and analysis of analog electrical and electronic circuits

**Expected results:** Design and analysis of electrical and electronic circuits (Electrical Engineering)

**Methodology: Lecture and tutorials** 

**Mandatory documentation: Lecture's mark** 

**Optional documentation: internet links; textbooks:** 

tests: intermediate 40 percent; final exam 60 percent:

Homeworks: there will be homeworks: groups and or individuals ones

# **Syllabus**

DIODES and APPLICATIONS: Introduction to semiconductors; PN junction; PN junction diodes; Half-wave rectifier; Full-wave rectifier; Zener diode; voltage stabilization by a Zener diode

Transistors: Introduction; Bipolar junction transistor; Transistor effect; Characteristics of transistors; Field effect transistors; Junction field effect transistors;

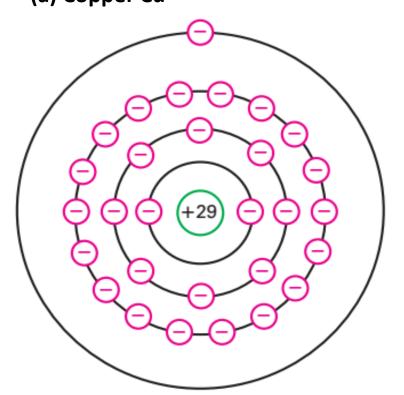
**Amplifier Transistors:** Biopolar Transistor Amplifiers; Field Effect Biopolar Transistors

Operational Amplifiers: Description; Characteristics and parameters of OA; Linear Approximation of OA circuits; Nonlinear approximation of OA circuits

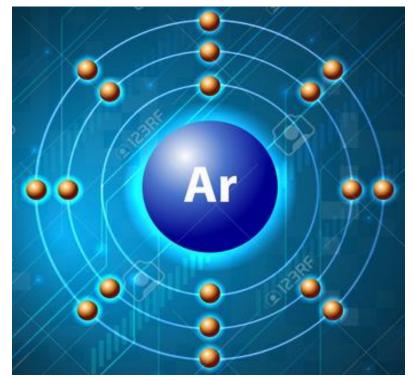
Diodes and transistors in commutation: Diodes in Switching; Biopolar Transistors in Switching; Field Effect Transistors in Switching;

#### Introduction

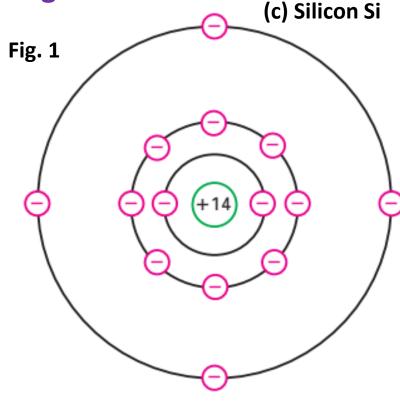
(a) Copper Cu Electronic conduction: passage of free electrons through a material.



Electrical conductors: Some materials which electricity pass through them easily.



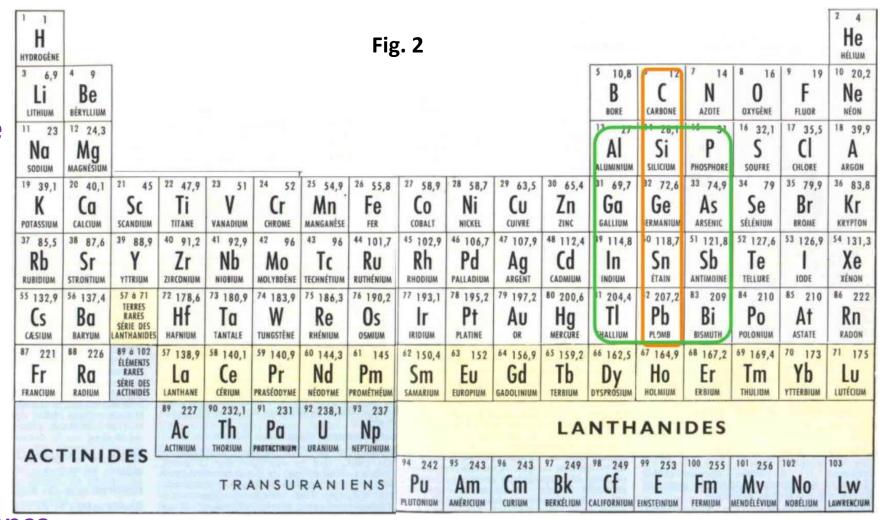
Electrical insulator: a material whose internal electric charges do not flow freely.



Electrical semiconductors: Some materials which electricity pass through them easily.

Best conductors (silver, copper, and gold) : 1 valence electron  $\sigma \approx 10^8~{
m S/m}$ 

Best insulators : 8 valence electrons  $\sigma < 10^{-6} \text{ S/m}$ 



**Best semiconductors: 4 valence** 

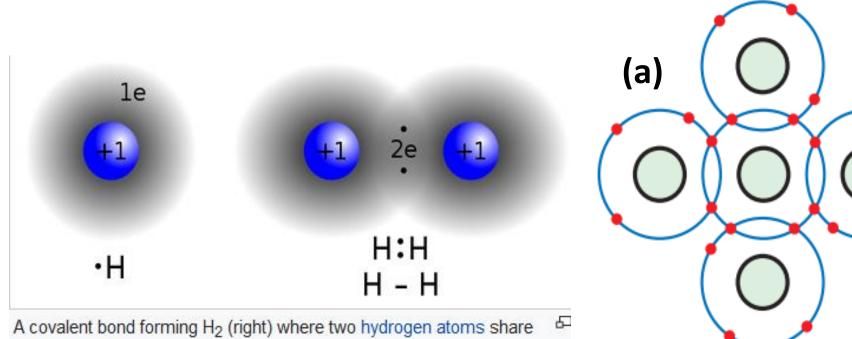
**electrons** 

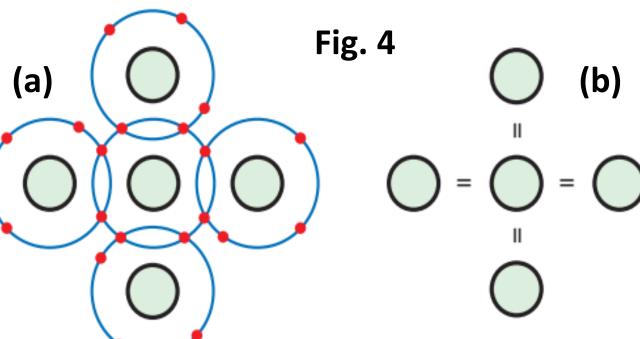
$$\sigma \approx 0.1 \text{ à } 10^{-4} \text{ S/m}$$

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Crystal or crystalline solid: solid material whose constituents (such as atoms, molecules, or ions) are arranged in a highly ordered microscopic structure, forming a crystal lattice that extends in all directions.

**Covalent Bond:** chemical bond that involves the sharing of electron pairs between atoms





A covalent bond forming H<sub>2</sub> (right) where two hydrogen atoms share the two electrons

Fig. 3

1 Si atom in crystal has 4 neighbors, 1 neighbor shares 1 electron with the central atom, 5 atoms have 8 atoms on each outer shell

Fig. 5 An cry orl

Ambient Temperature > 0, heat energy induces vibrations of Si atoms in the crystal, some electrons of outer shells may be dislodged, move to higher orbit, thus are free to move along the crystal, few electrons are produced

HOLE: The departure of the electron creates a vacancy in the valence orbit called a hole that behaves like a positive ion (departure of electron = positive ion) and attract any electron in its attract and capture any electron in the immediate vicinity.

Free electrons move randomly throughout the crystal. Occasionally, a free electron will approach a hole, feels its attraction, and fall into it

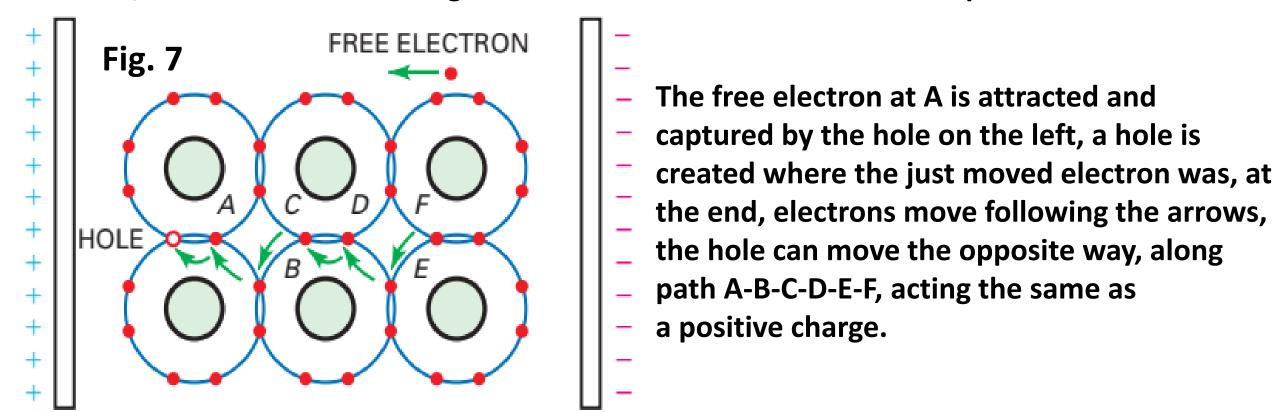
Recombination: merging of a free electron and a hole

lifetime: amount of time between the creation and disappearance of a free electron, from nanoseconds to microseconds

Fig. 6

Intrinsic semiconductors: Pure semiconductors, have less than one impurity per  $10^{15}$  atoms; characteristics close to insulators

A free electron in a large orbit at right end of crystal, due to negatively charged plate, is repelled to the left, can move from one large orbit to the next until it reaches the positive one



#### Two opposite flows in an intrinsic semiconductor

Thermal agitation creates same number of free electrons and holes

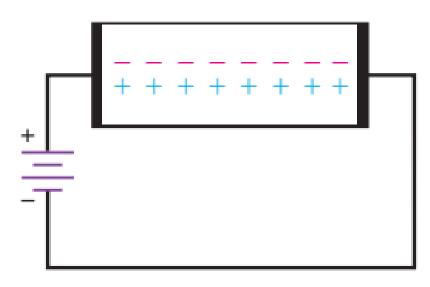


Fig. 8

The applied voltage forces free electrons to flow left but holes to flow right; free electrons arriving at left end of the crystal enter the external wire and flow to the positive battery terminal

Free electrons at the negative battery terminal flow to right end of the crystal, enter the crystal and recombine with holes that arrive at the right end of crystal.

No hole flows outside the semiconductor

Free electrons and holes are often called carriers because they carry a charge from one place to another

#### **DOPING A SEMICONDUCTOR**

Extrinsic semiconductors: adding impurities to a pure semiconductor to the order of 1 impurity per  $10^5$  -  $10^8$  atoms results to a drastic dropping of its resistivity hence increasing it electrical conductivity; the semiconductor is a called a doped semiconductor or an extrinsic semiconductor

#### Increase the number of free electrons

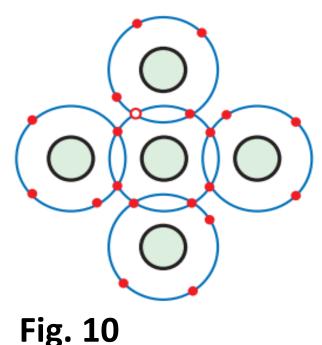
FREE ELECTRON

Fig. 9

To increase the number of free electrons, pentavalent atoms are added to the molten pure semiconductor, thus the pure semiconductor is first melted

Fig. 8 case of Si pure semiconductor, each pentavalent atom brings 1 free electron as the four other enter four covalent bonds with 4 neighboring Si atoms, each pentavalent atom is called a donor atom

Heavily doped semiconductors have lower resistance, thus higher electrical conductivity



#### Increase the number of holes

Adding a trivalent impurity in a pure semiconductor, one whose atoms have only three valence electrons, a semiconductor with an excess holes is created

Fig. 10 case of a pure Si semiconductor doped with a trivalent atom, the trivalent atom at the center shares its 3 valence electrons with its 4 Si atoms neighbors, a hole appears since there are only 7 electrons on the valence orbit of the trivalent atom

The inserted trivalent atom is called an acceptor atom since each hole can accepts or captures a free electron

Types of extrinsic simiconductors

Fig. 11

N-type semiconductor: a semiconductor that has been doped with a pentavalent impurity; it has an excess of free electrons, free electrons outnumber the holes see Fig. 11

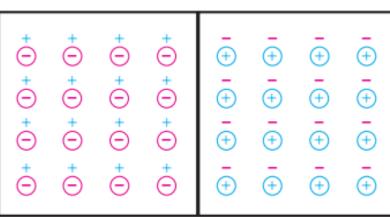
Free electrons: majority carriers

**Holes:** minority carriers

P-type semiconductor: a semiconductor that has been doped with a trivalent impurity; it has an excess of holes, holes outnumber free electrons see Fig. 12

**Holes:** majority carriers

**Electrons: minority carriers** 



PN- junction: border between P-type and N-type semiconductors

Fig 12 left side: red circled - are trivalent atoms, blue + are holes right side: blue circled + are pentavalent atoms, red – free electrons, this PN crystal is also called a junction diode is

Fig. 13

Diffusion: free electrons in the N- side of Fig, 13 diffuse due to repulsions among them; some cross the junction, a free electron that enter the P region becomes a minority carriers, has a short lifetime as it soon recombines with a hole, hence becomes a valence electron and the hole 'disappears'

lons pairs creation: each free electron that diffuses across the junction induces a pentavalent positively charge in N-side, it creates a negative ion in P-side as it is captured by a hole from a trivalent atom, both ions created in each side of the junction are fixe object since they cannot move like free electrons due to covalent bonding

IONS

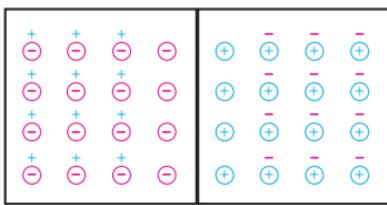
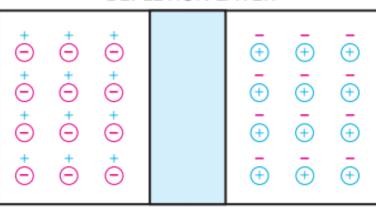


Fig. 14 circled + are positive ions, circled – negative ions, Creation of ions near the junction

Dipole: a pair of positive and negation ions near the junction, the creation of a dipole means a reduction charge carriers (e-)

Fig. 14

**DEPLETION LAYER** 



Depletion layer: the number of dipoles increases, the region near the junction is emptied of charge carriers, the empty region is called depletion layer, see Fig. 15

Fig. 15

IONS

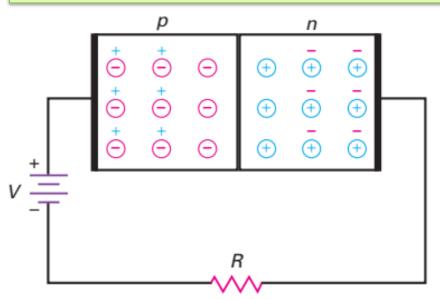
too up to an equilibrium is riched; at this equilibrium, any electrons entering the depletion layer is repelled the electric field

Fig. 14

as the number of electrons crossing the junction increases, the electric field increases too up to an equilibrium is riched; at this equilibrium, any electrons entering the depletion layer is repelled by the electric field, its electric potential,  $V_0$ , is the potential barrier

$$\vec{E}_{int} = -\overrightarrow{grad}V_0$$
;  $V_0 \approx 0.7 \text{ V, for a Si at } 25^0 \text{ C}$ 

 $V_0$  stops the motion of free carriers; minority carriers can cross the depletion layer; existence of a tiny electric current passing through the depletion layer due to minority carriers



#### Forward bias diode

Positive source terminal is connected to the P-type material Negative source terminal is connected to the N-type material

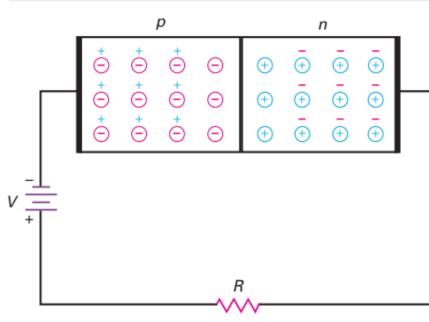
 $V < V_0$  free electrons do not have enough energy to cross the depletion layer, they are reppelled, no current circulation

Fig. 16 forward bias diode

 $V > V_0$  free electrons have enough energy to cross the depletion layer, continuous current through the diode

The width of the depletion layer reduces

 $V > V_0 = 0.7 \ V$ , continuous current through Si diode from P to N; this is called forward current



#### Reverse bias diode

Positive source terminal is connected to the N-type material Negative source terminal is connected to the P-type material

The depletion layer widens with encreasing applied voltage V, the depletion layer stops growing for  $V=V_0$ , electrons and holes stop moving away from the junction

Fig. 17 reverse bias diode

There exists a current passing through the depletion layer stemming from minority carriers, this is called saturation current  $I_S$ ,  $I_S \approx 0$ 

Origin of  $I_S$ : thermal energy produces free electrons and holes in the depletion layer, these minority carriers cross the depletion layer

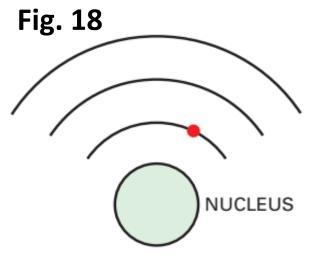
surface-leakage current: small current flowing on the surface of the crystal due to surface impurities and imperfections of the crystal

#### **Breakdown voltage**

Diodes have maximum voltage ratings, breakdown voltage is the limit voltage after which the reverse bias diode will be destroyed is the external voltage is increased

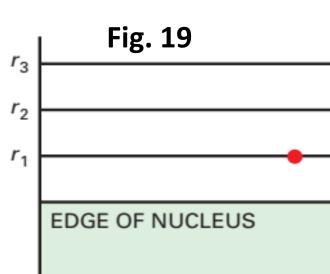
At the breakdown voltage, the diode conducts heavily as a large number of minority carriers appear in the depletion layer;

As the reverse voltage increases, the velocity of minority carriers increases too, after a collision between one minority carrier and a valence electron of an atom of the crystal, an electron might be expelled from the valence orbit to a large one and becomes a free moving carrier, now 2 moving carriers expel 2 electrons and there are 4 free carriers and so on, this the avalanche effect



#### **Energy levels and electrical conduction**

Fig. 18 In an atom, energy level of an electron is proportional to its orbit size or the radius of its orbit, electrons energy increases with increasing radiuses, the first energy level corresponds to electrons in the first orbit ... only specific orbits are allowed,



in order to lift an electron from its orbit (energy level) to a higher orbit (higher energy level), external energy is needed to overcome the electrostatic attraction from the nucleus, external energy that can be brought are: heat, light, voltage

Fig. 19 shows energy levels of electrons of an isolated atom; energy levels of electrons are influenced only by other charges of the atom

#### **Energy bands**

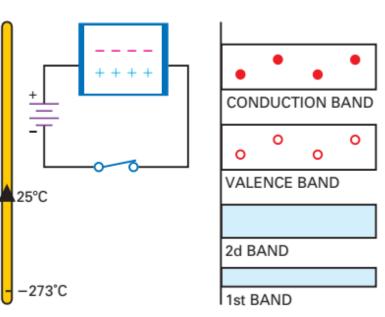
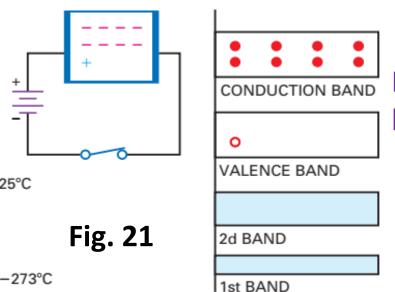


Fig. 20 energy bands of an intrinsic semiconductor

For atoms in a crystal, the energy level of each electron is influenced by the presence of the charges of that atom and also the many charges of the rest of the atoms in the crystal, each electron has a unique energy level as it is not affected in the way by other charges of the crystal

For atoms in a crystal, the energy level of each electron is influenced by the presence of the charges of that atom and also the many charges of the rest of the atoms in the crystal, each electron has a unique energy level as it is not affected in the same way by other charges of the crystal, hence each energy level is occupied by many electrons with almost the same energy, one has energy bands since there are billions of atoms in the crystal

Thermal energy produces a few free electrons and holes, free electrons move to the higher energy level, the conduction band, holes move in the valence band

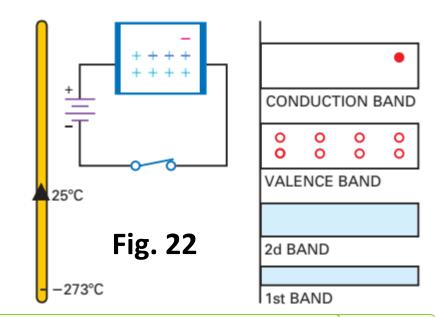


**Energy bands in an N-typ semiconductor** 

Fig. 21 There are more free electrons that occupy the conduction band, few holes in the valence band

**Energy bands in a P-typ semiconductor** 

Fig. 22 There are more holes that occupy the conduction band, few free electrons in the valence band



#### **Current flowing through the PN junction**

**Current in forward bias diode** 

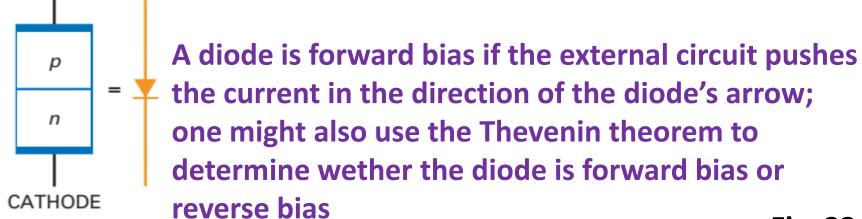
$$I = I_S\left(\mathrm{e}^{\frac{qV}{kT}} - 1\right)$$
 Eq. (1)

**Current in reverse bias diode** 

$$I \approx 0 A$$

Eq. (2)

# DIODES



ANODE

Fig. 22 Diode symbol

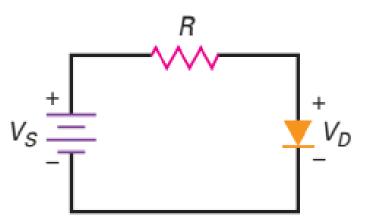
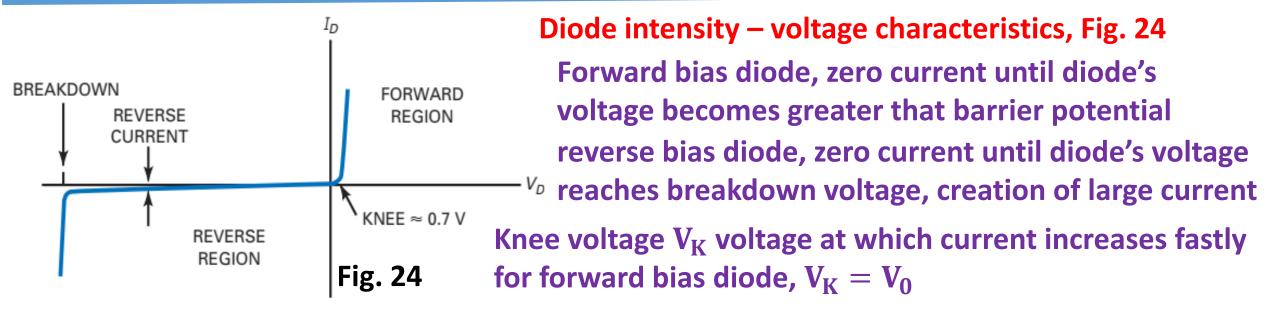


Fig. 23 diode forward bias in a circuit



#### **DIODES**

Diode bulk resistance: sum of resistances of the P-type and N-type,  $R_{\rm B}=R_{\rm P}+R_{\rm N}$ 

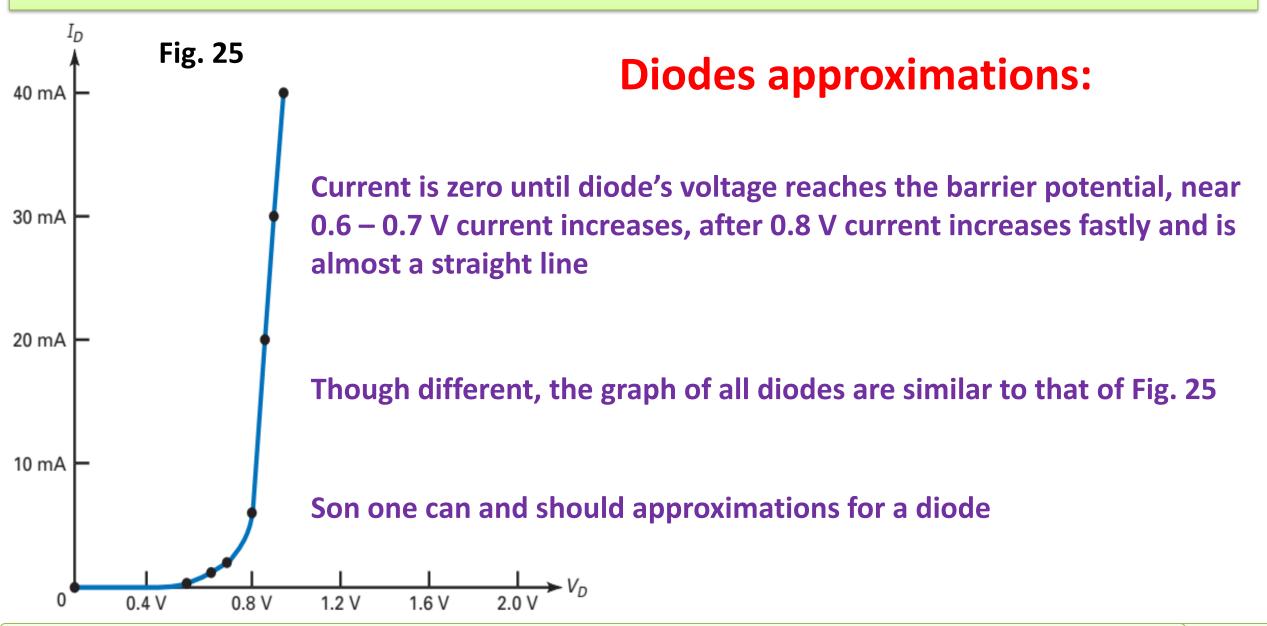
Maximum forward current: maximum current a diode can safely handle without shortening its life or degrading its characteristics

Power dissipation 
$$P_D = V_D I_D$$
 Eq. (3)

Power rating: maximum power the diode can safely dissipate without shortening its life or degrading its properties

$$P_{max} = V_{max}I_{max} \quad \text{Eq. (4)}$$

## DIODES



# **DIODES: approximations**

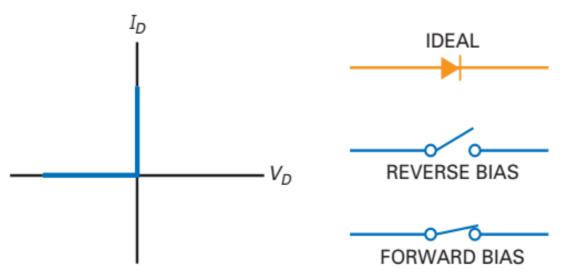
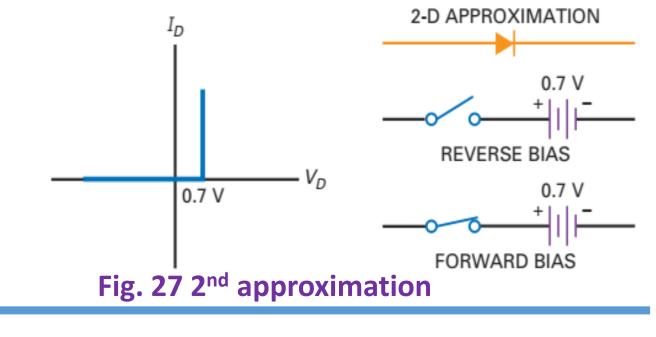


Fig. 26 ideal case, 1st approximation



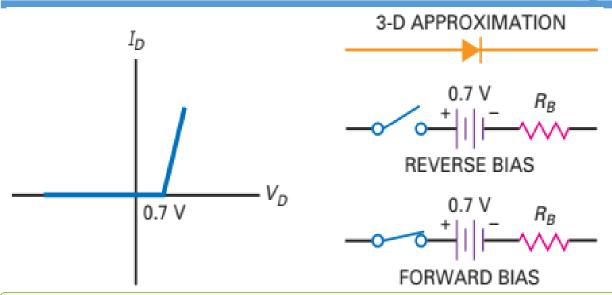


Fig. 28 3<sup>rd</sup> approximation

# **DIODES: approximations**

#### **Load line analysis** $R_S$ Current through the diode $I_D = \frac{V_S - V_D}{R_c}$ Eq. (5)

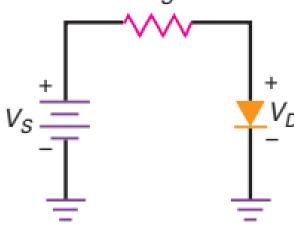


Fig. 29

$$I_D = \frac{V_S - V_D}{R_S}$$
 Eq. (5)

Saturation point: maximum current corresponding to

source voltage 
$$V_S$$
 and load  $R_S$ ,  $V_D = 0$   $I_D = V_S/R_S$ 

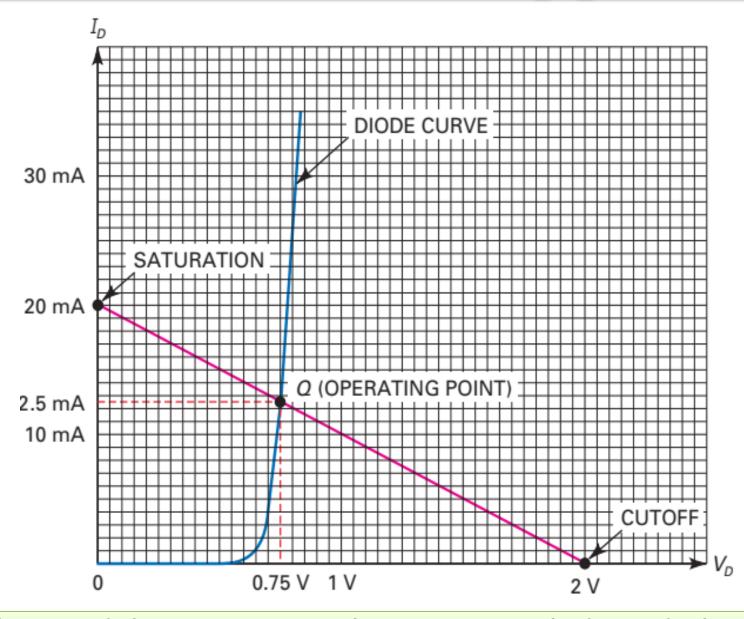
Eq. (6)

Cutoff point: minimum diode current 
$$I_D = 0$$
  $V_D = V_S$  Eq. (7)

Load line: geometric representation of Eq.(5)

Operating point or Q point: intersection between the load line and diode curve; it works both for the circuit and the diode

# **DIODES: approximations**



#### **Load line analysis**

Fig. 30

## Diode applications: half-wave rectifier

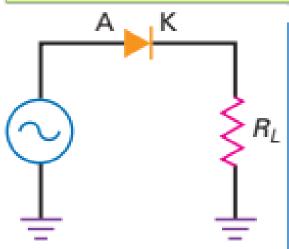
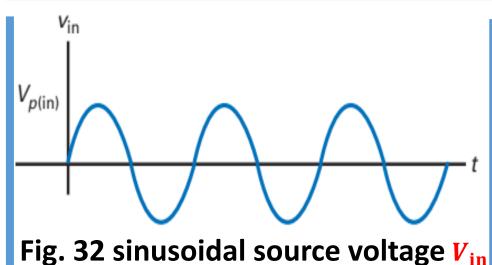
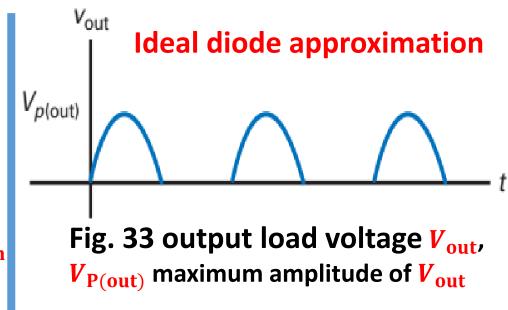


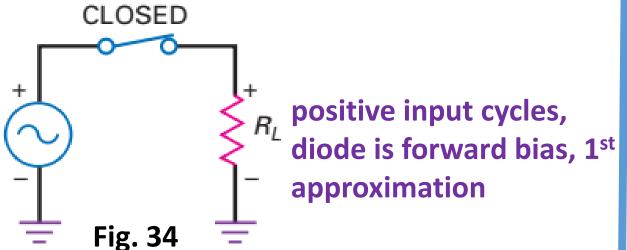
Fig. 31 half-wave

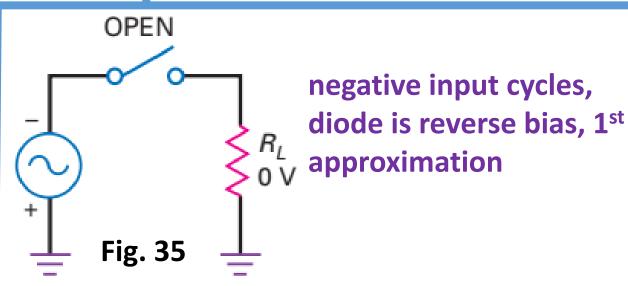
rectifier circuit



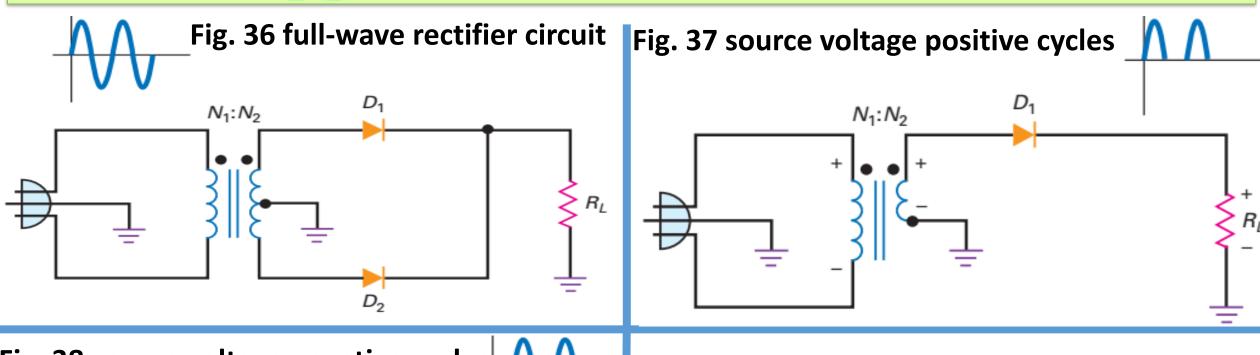
 $V_{P(in)}$  maximum amplitude of  $V_{in}$ 

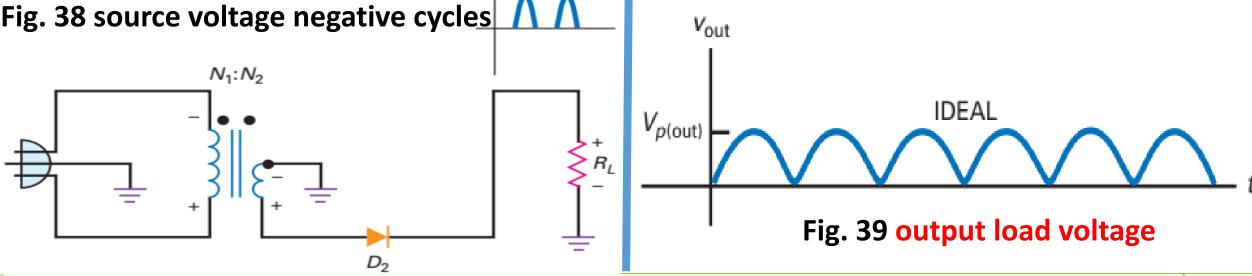






#### Diode applications: full-wave rectifier





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# Diode applications: zener diode

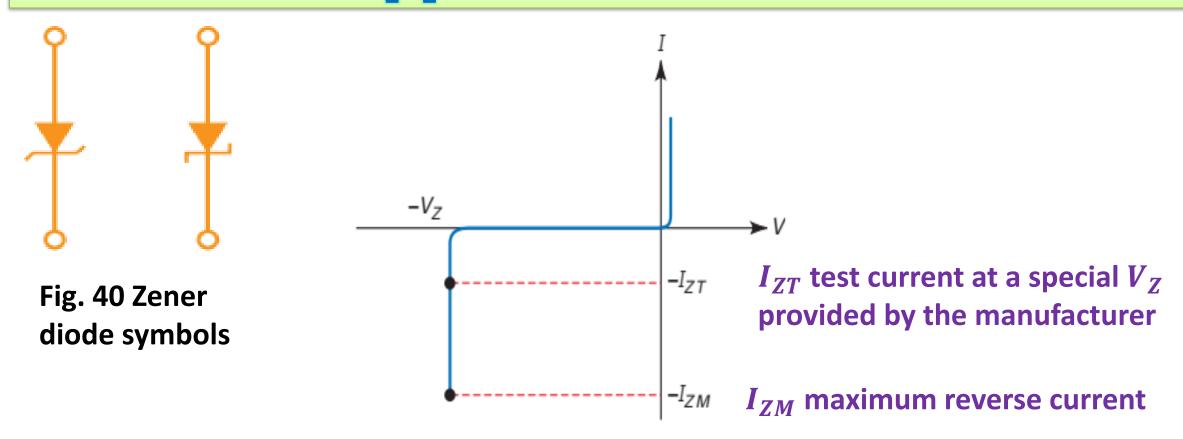
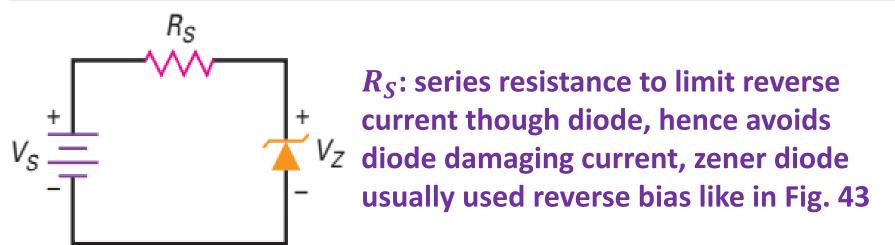


Fig. 41 Zener diode current to voltage curve

Zener resistance: inverse of slope in the breakdown region, resistance in the breakdown region

## Diode applications: zener diode



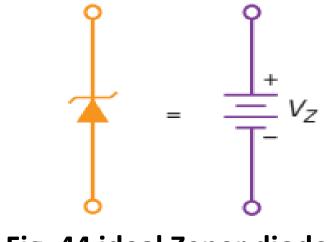


Fig. 44 ideal Zener diode

Fig. 43 Zener diode reverse bias

Zener effect: creation of a large number of free electrons by removing them from their valence orbit due to an intense electric field

Zener effect appears in the breakdown region of a Zener diode, the reverse current becomes very high